

# Complementary MOSFET

## ELM35602KA-S

### ■ General Description

ELM35602KA-S uses advanced trench technology to provide excellent  $R_{ds(on)}$  and low gate charge.

### ■ Features

|  |   |
|--|---|
| N-channel                                  | P-channel                                   |
| $V_{ds}=30V$                               | $V_{ds}=-30V$                               |
| $I_d=8A$                                   | $I_d=-6A$                                   |
| $R_{ds(on)} < 25m\Omega$ ( $V_{gs}=10V$ )  | $R_{ds(on)} < 45m\Omega$ ( $V_{gs}=-10V$ )  |
| $R_{ds(on)} < 37m\Omega$ ( $V_{gs}=4.5V$ ) | $R_{ds(on)} < 80m\Omega$ ( $V_{gs}=-4.5V$ ) |

### ■ Maximum Absolute Ratings

| Parameter                              | Symbol         | N-ch (Max.) | P-ch (Max.) | Unit | Note |
|--|----------------|-------------|-------------|------|------|
| Drain-source voltage                   | $V_{ds}$       | 30          | -30         | V    |      |
| Gate-source voltage                    | $V_{gs}$       | $\pm 20$    | $\pm 20$    | V    |      |
| Continuous drain current               | $I_d$          | 8.0         | -6.0        | A    |      |
|  |                | 6.5         | -4.8        |      |      |
| Pulsed drain current                   | $I_{dm}$       | 50          | -50         | A    | 1    |
| Power dissipation                      | $P_d$          | 3.0         | 3.0         | W    |      |
|  |                | 2.1         | 2.1         |      |      |
| Junction and storage temperature range | $T_j, T_{stg}$ | -55 to 150  | -55 to 150  | °C   |      |

### ■ Thermal Characteristics

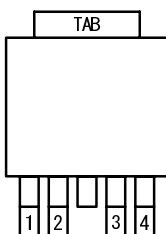
| Parameter                   | Symbol          | Device | Typ. | Max. | Unit | Note |
|-----------------------------|-----------------|--------|------|------|------|------|
| Maximum junction-to-ambient | $R_{\theta ja}$ | N-ch   |      | 42   | °C/W |      |
| Maximum junction-to-case    | $R_{\theta jc}$ | N-ch   |      | 6    | °C/W |      |
| Maximum junction-to-ambient | $R_{\theta ja}$ | P-ch   |      | 42   | °C/W |      |
| Maximum junction-to-case    | $R_{\theta jc}$ | P-ch   |      | 6    | °C/W |      |

1. Pulse width limited by maximum junction temperature.

2. Duty cycle  $\leq 1\%$ .

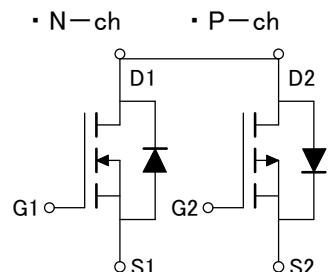
### ■ Pin Configuration

TO-252-4 (TOP VIEW)



| Pin No. | Pin name      |
|---------|---------------|
| 1       | SOURCE1       |
| 2       | GATE1         |
| 3       | SOURCE2       |
| 4       | GATE2         |
| TAB     | DRAIN1/DRAIN2 |

### ■ Circuit



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### ■ Electrical Characteristics (N-ch)

T<sub>a</sub>=25°C

| Parameter                          | Symbol  | Conditions                            | Min. | Typ. | Max. | Unit | Note |
|------------------------------------|---------|---------------------------------------|------|------|------|------|------|
| <b>STATIC PARAMETERS</b>           |         |                                       |      |      |      |      |      |
| Drain-source breakdown voltage     | BVdss   | Id=250 μA, Vgs=0V                     | 30   |      |      | V    |      |
| Zero gate voltage drain current    | Idss    | Vds=24V, Vgs=0V                       |      |      | 1    | μA   |      |
|                                    |         | Vds=20V, Vgs=0V, Tj=55°C              |      |      | 10   |      |      |
| Gate-body leakage current          | Igss    | Vds=0V, Vgs=±20V                      |      |      | ±100 | nA   |      |
| Gate threshold voltage             | Vgs(th) | Vds=Vgs, Id=250 μA                    | 1.0  | 1.5  | 2.5  | V    |      |
| On state drain current             | Id(on)  | Vgs=10V, Vds=5V                       | 50   |      |      | A    | 1    |
| Static drain-source on-resistance  | Rds(on) | Vgs=10V, Id=8A                        |      | 18   | 25   | mΩ   | 1    |
|                                    |         | Vgs=4.5V, Id=7A                       |      | 25   | 37   |      |      |
| Forward transconductance           | Gfs     | Vds=10V, Id=8A                        |      |      | 19   | S    | 1    |
| Diode forward voltage              | Vsd     | If=3A, Vgs=0V                         |      |      | 1.3  | V    | 1    |
| <b>DYNAMIC PARAMETERS</b>          |         |                                       |      |      |      |      |      |
| Input capacitance                  | Ciss    | Vgs=0V, Vds=10V, f=1MHz               |      | 790  |      | pF   |      |
| Output capacitance                 | Coss    |                                       |      | 175  |      | pF   |      |
| Reverse transfer capacitance       | Crss    |                                       |      | 65   |      | pF   |      |
| <b>SWITCHING PARAMETERS</b>        |         |                                       |      |      |      |      |      |
| Total gate charge                  | Qg      | Vgs=10V, Vds=15V, Id=8A               |      | 16.0 |      | nC   | 2    |
| Gate-source charge                 | Qgs     |                                       |      | 2.5  |      | nC   | 2    |
| Gate-drain charge                  | Qgd     |                                       |      | 2.1  |      | nC   | 2    |
| Turn-on delay time                 | td(on)  | Vgs=10V, Vds=10V, Id ≈ 1A<br>Rgen=6 Ω |      | 2.2  | 4.4  | ns   | 2    |
| Turn-on rise time                  | tr      |                                       |      | 7.5  | 15.0 | ns   | 2    |
| Turn-off delay time                | td(off) |                                       |      | 11.8 | 21.3 | ns   | 2    |
| Turn-off fall time                 | tf      |                                       |      | 3.7  | 7.4  | ns   | 2    |
| Body diode reverse recovery time   | trr     | If=8A, dl/dt=100A/μs                  |      | 42   |      | ns   |      |
| Body diode reverse recovery charge | Qrr     |                                       |      | 30   |      | nC   |      |

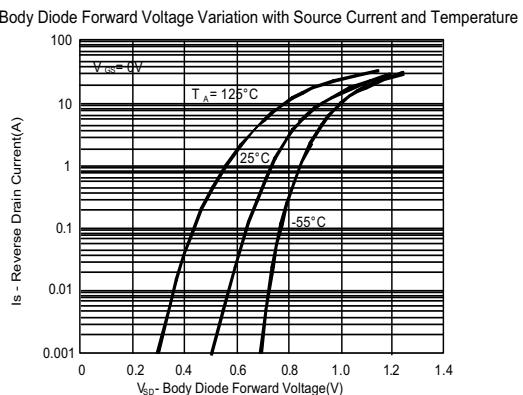
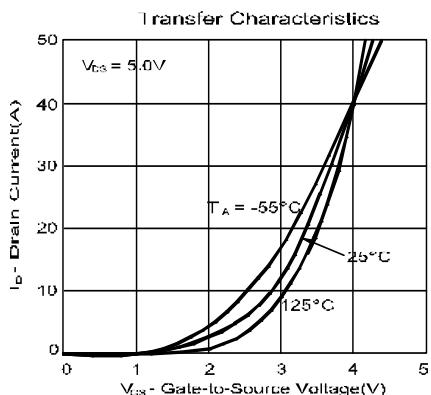
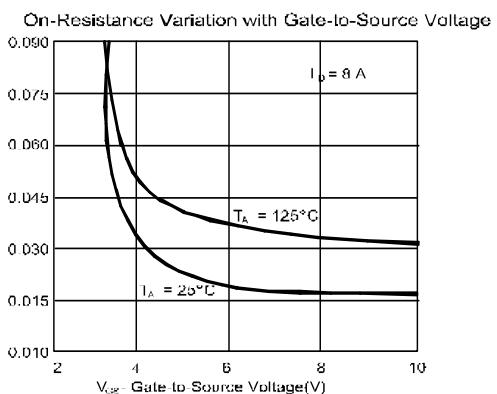
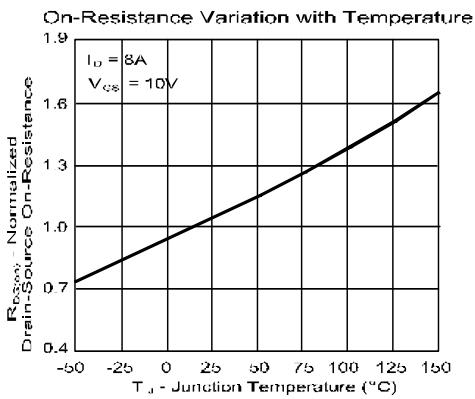
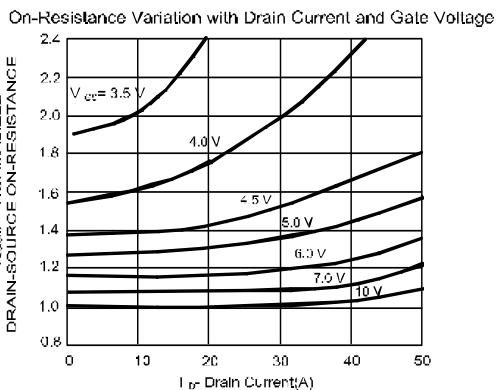
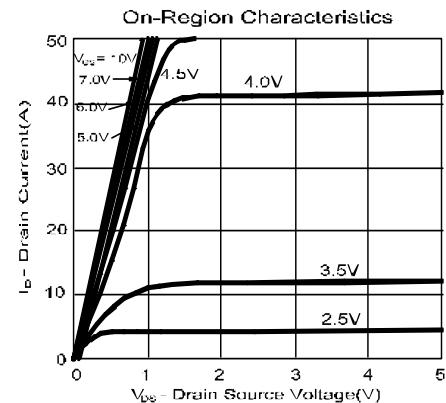
NOTE :

1. Pulse test : Pulse width ≤ 300 μsec, duty cycle ≤ 2%.
2. Independent of operating temperature.
3. Pulse width limited by maximum junction temperature.

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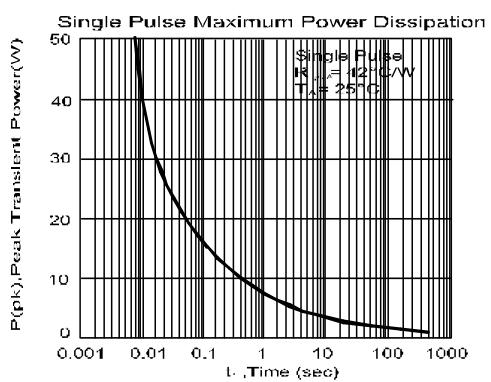
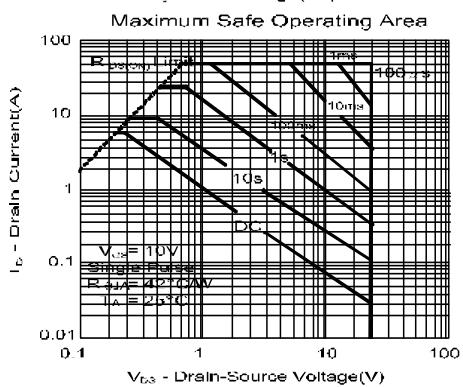
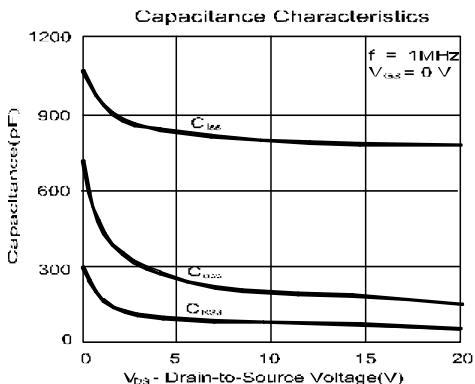
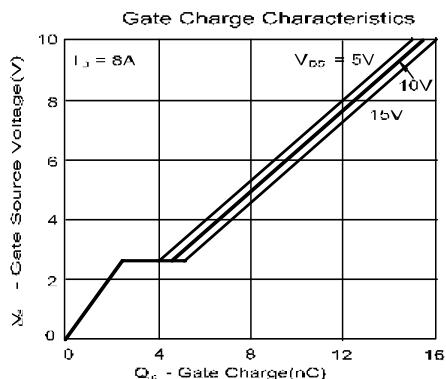
ELM35602KA-S

## ■ Typical Electrical and Thermal Characteristics (N-ch)



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### ■ Electrical Characteristics (P-ch)

T<sub>a</sub>=25°C

| Parameter                          | Symbol  | Conditions                               | Min. | Typ. | Max. | Unit | Note |
|------------------------------------|---------|--|------|------|------|------|------|
| <b>STATIC PARAMETERS</b>           |         |  |      |      |      |      |      |
| Drain-source breakdown voltage     | BVdss   | Id=-250 μA, Vgs=0V                       | -30  |      |      | V    |      |
| Zero gate voltage drain current    | Idss    | Vds=-24V, Vgs=0V                         |      |      | -1   | μ A  |      |
|                                    |         | Vds=-20V, Vgs=0V, Tj=55°C                |      |      | -10  |      |      |
| Gate-body leakage current          | Igss    | Vds=0V, Vgs=±20V                         |      |      | ±100 | nA   |      |
| Gate threshold voltage             | Vgs(th) | Vds=Vgs, Id=-250 μA                      | -1.0 | -1.5 | -2.5 | V    |      |
| On state drain current             | Id(on)  | Vgs=-10V, Vds=-5V                        | -50  |      |      | A    | 1    |
| Static drain-source on-resistance  | Rds(on) | Vgs=-10V, Id=-6A                         |      | 34   | 45   | m Ω  | 1    |
|                                    |         | Vgs=-4.5V, Id=-5A                        |      | 58   | 80   |      |      |
| Forward transconductance           | Gfs     | Vds=-10V, Id=-6A                         |      | 11   |      | S    | 1    |
| Diode forward voltage              | Vsd     | If=-3A, Vgs=0V                           |      |      | -1.3 | V    | 1    |
| <b>DYNAMIC PARAMETERS</b>          |         |  |      |      |      |      |      |
| Input capacitance                  | Ciss    | Vgs=0V, Vds=-10V, f=1MHz                 |      | 690  |      | pF   |      |
| Output capacitance                 | Coss    |  |      | 310  |      | pF   |      |
| Reverse transfer capacitance       | Crss    |  |      | 75   |      | pF   |      |
| <b>SWITCHING PARAMETERS</b>        |         |  |      |      |      |      |      |
| Total gate charge                  | Qg      | Vgs=-10V, Vds=-15V<br>Id=-6A             |      | 14.0 |      | nC   | 2    |
| Gate-source charge                 | Qgs     |  |      | 2.2  |      | nC   | 2    |
| Gate-drain charge                  | Qgd     |  |      | 1.9  |      | nC   | 2    |
| Turn-on delay time                 | td(on)  | Vgs=-10V, Vds=-10V<br>Id ≈ -1A, Rgen=6 Ω |      | 6.7  | 13.4 | ns   | 2    |
| Turn-on rise time                  | tr      |  |      | 9.7  | 19.4 | ns   | 2    |
| Turn-off delay time                | td(off) |  |      | 19.8 | 35.6 | ns   | 2    |
| Turn-off fall time                 | tf      |  |      | 12.3 | 22.2 | ns   | 2    |
| Body diode reverse recovery time   | trr     | If=-6A, dl/dt=100A/μs                    |      | 55   |      | ns   |      |
| Body diode reverse recovery charge | Qrr     |  |      | 52   |      | nC   |      |

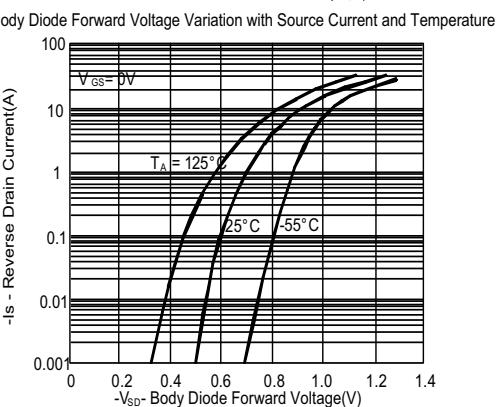
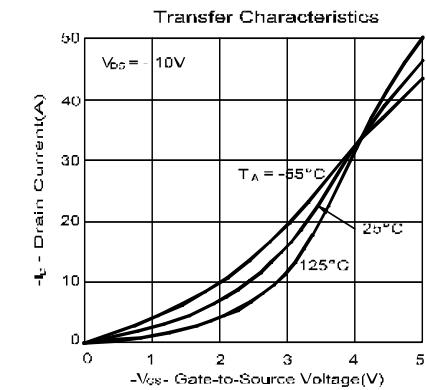
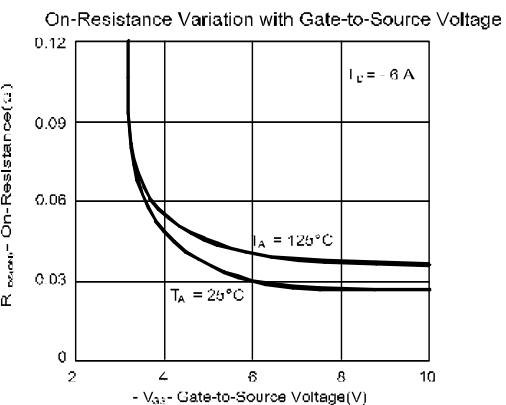
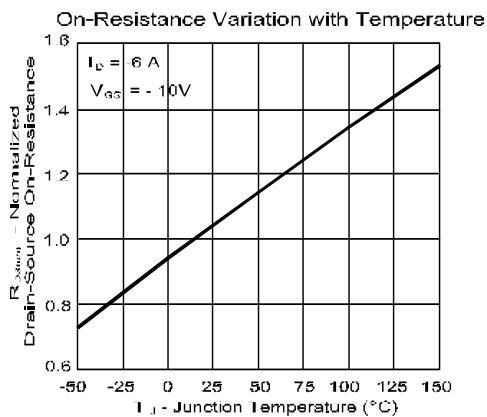
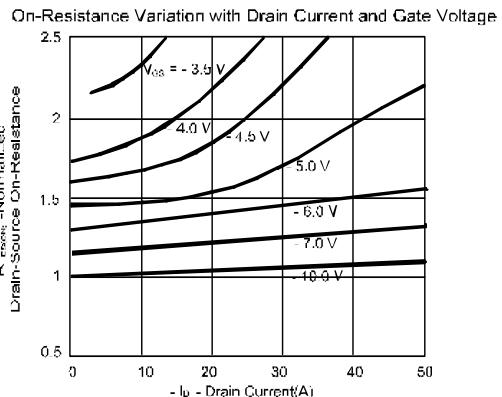
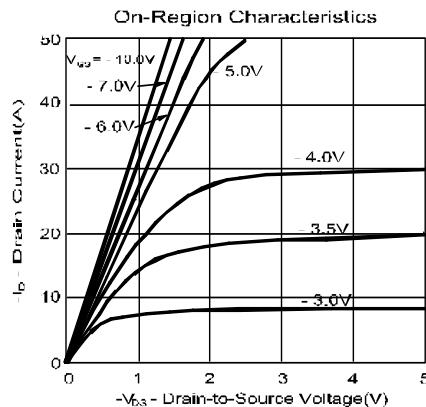
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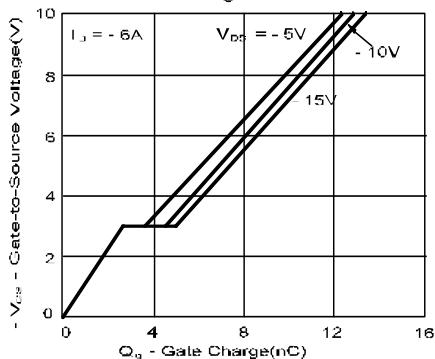
## ■ Typical Electrical and Thermal Characteristics (P-ch)



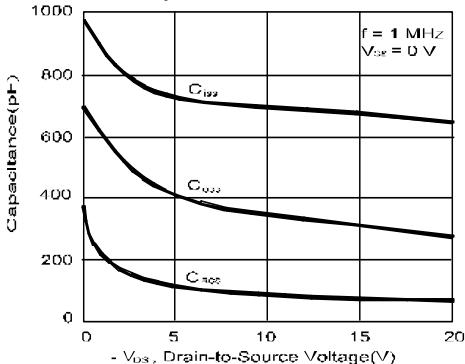
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**ELM35602KA-S**

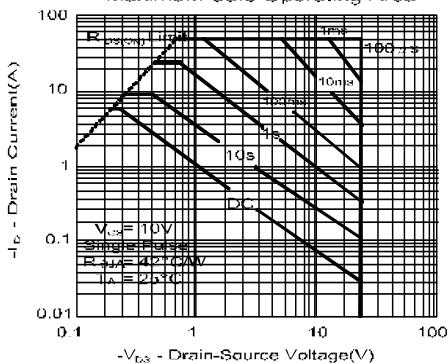
**Gate Charge Characteristics**



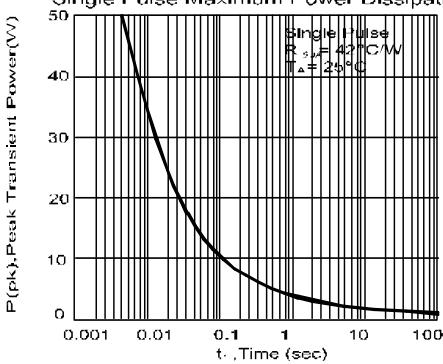
**Capacitance Characteristics**



**Maximum Safe Operating Area**



**Single Pulse Maximum Power Dissipation**



**Transient Thermal Response Curve**

